See-Cure 211-CTH-SC
LED-Curable, Plastic-Bonding Adhesive for Catheter Assembly

APPLICATIONS

- Y-Connector Assembly
- Connectors to Tubing
- Balloon Bonding
- Catheter Assembly

FEATURES

- Curable with BlueWave® LED Prime UVA
- Tack-Free Cure in as Little as 4 Seconds
- Adhesion to Wide Variety of Plastics
- See-Cure Technology: Blue to Clear Upon Exposure to UV/Visible
- UV/Visible Light Cure
- Ideal for >1 W/cm^2
- Ideal for 4-8 mil gaps

RECOMMENDED SUBSTRATES

- Polycarbonate
- Polyurethane
- Polystyrene
- Stainless Steel

BIOCOMPATIBILITY

- ISO 10993-4 Hemolysis
- ISO 10993-5 Cytotoxicity
- ISO 10993-6 Implantation (Short Term)
- ISO 10993- 10 Sensitization/Irritation
- ISO 10993-11 Systemic Toxicity (Acute)

Dymax MD® Medical Device Adhesive 211-CTH-SC is designed for rapid bonding of metals and a wide variety of plastics typically used in the manufacture of medical devices. The blue color of Dymax See-Cure products disappears when they are fully cured. Dymax MD® Medical Device adhesives contain no nonreactive solvents and cure upon exposure to light. Their ability to cure in seconds enables faster processing, greater output, and lower processing costs. When cured with Dymax light-curing spot lamps or focused-beam lamps, they deliver optimum speed and performance for medical device assembly. Dymax lamps offer the ideal balance of UV and visible light for the fastest, deepest cures. This product is in full compliance with the RoHS Directives 2002/95/EC and 2003/11/EC.

UNCURED PROPERTIES *

Property	Value	Test Method
Solvent Content	No Nonreactive Solvents	N/A
Chemical Class	Acrylated Urethane	N/A
Appearance	Blue Transparent Liquid	N/A
Soluble in	Organic Solvents	N/A
Density, g/ml	1.03	ASTM D1875
Viscosity, cP (20 rpm)	450 (nominal)	DSTM 502‡

CURED MECHANICAL PROPERTIES *

Property	Value	Test Method
Durometer Hardness	D70	ASTM D2240
Tensile at Break, MPa [psi]	16 [2,400]	ASTM D638
Elongation at Break, %	100	ASTM D638
Modulus of Elasticity, MPa [psi]	320 [46,000]	ASTM D638

CURED MECHANICAL PROPERTIES * BlueWave® LED Prime UVA

Property	Value	Test Method
Tensile at Break, MPa [psi]	14 [2,350]	N/A
Elongation at Break, %	97	N/A
Modulus of Elasticity, MPa [psi]	230 [45,100]	N/A

OTHER CURED PROPERTIES *

Property	Value	Test Method
Appearance	Clear/Straw Color	N/A
Refractive Index (20˚C)	1.50	ASTM D542
Boiling Water Absorption, % (2 hr)	6.0	ASTM D570
Water Absorption, % (25˚C, 24 hr)	4.4	ASTM D570
Linear Shrinkage, %	0.59	ASTM D2566
Glass Transition, T_g	104˚C	DSTM 256‡

* Not Specifications
N/A Not Applicable
‡ DSTM Refers to Dymax Standard Test Method

ADHESION

Substrate	Recommendation
ABS acrylonitrile-butadiene-styrene	✓
CAP cellulose acetate propionate	✓
PA polyamide	✓
PC polycarbonate	✓
PVC poly(vinyl chloride)	✓
SAN styrene-acrylonitrile	✓
TPU thermoplastic polyurethane	✓
FR-4 epoxy	✓

✓ Recommended Adhesive o Limited Applications
st Requires Surface Treatment (e.g. plasma, corona treatment, etc.)

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CURING GUIDELINES

The blue color of Dymax See-Cure products disappears when they are fully cured. Full cure is achieved when additional light exposure does not improve cured properties. The charts below provide information on how long it takes to complete the transition from blue to clear, using different light sources and adhesive thicknesses.

Dymax Curing System (Intensity)	5000-EC (200 mW/cm²) [A]
Adhesive Thickness, mm [mil]	**Time to complete transition, sec [B]**
0.10 [4.0]	8
0.20 [8.0]	20
0.41 [16]	30
0.81 [32]	35

Dymax Curing System (Intensity)	BlueWave® 200 (10 W/cm²) [A, C]
Adhesive Thickness, mm [mil]	**Time to complete transition, sec [B]**
0.10 [4.0]	1
0.20 [8.0]	1
0.41 [16]	1
0.81 [32]	10

Dymax Curing System (Intensity)	UVCS Conveyor with Fusion F300 (2.5 W/cm²) [D]
Adhesive Thickness, mm [mil]	**Belt speed to complete transition, m/min [ft/min] [B]**
0.10 [4.0]	0.76 m/min [2.5 ft/min]
0.20 [8.0]	0.76 m/min [2.5 ft/min]
0.41 [16]	1.22 m/min [4 ft/min]
0.81 [32]	1.52 m/min [5 ft/min]

Dymax Curing System (Intensity)	BlueWave® LED Prime UVA (16 W/cm²)
Adhesive Thickness, mm [mil]	**Time to complete transition, sec [B]**
0.10 [4.0]	3
0.20 [8.0]	4
0.41 [16]	2
0.81 [32]	1

A *Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 50 Radiometer.*

B *Curing through light-blocking substrates may limit the ability of See-Cure adhesives to transition from blue to clear and may require longer light exposure at critical wavelengths (320-400 nm for UV light curing; 320-450 nm for UV/Visible light curing). These times/speeds are typical for curing through 100% light-transmitting substrates.*

C *Due to the distance between the end of the lightguide and adhesive, intensity at the curing area was measured as 4.0 W/cm².*

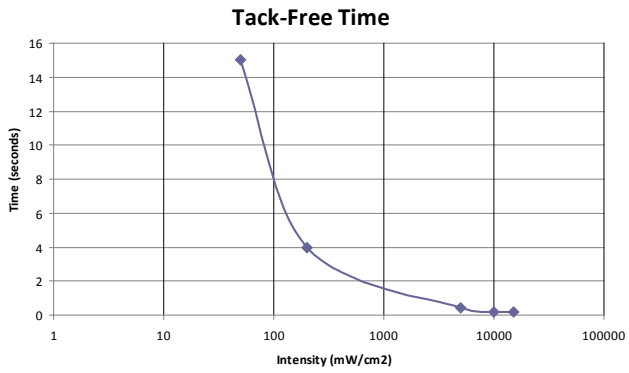
D *At 53 mm [2.1 in] focal distance. Maximum speed of conveyor is 8.2 m/min [27 ft/min]. Intensity was measured over the UVA range (320-395 nm) using the Dymax ACCU-CAL™ 100 Radiometer.*

Full cure is best determined empirically by curing at different times and intensities, and measuring the corresponding change in cured properties such as tackiness, adhesion, hardness, etc. Full cure is defined as the point at which more light exposure no longer improves cured properties. Higher intensities or longer cures (up to 5x) generally will not degrade Dymax light-curable adhesives.

Dymax recommends that customers employ a safety factor by curing longer and/or at higher intensities than required for full cure. Although Dymax Application Engineering can provide technical support and assist with process development, each customer ultimately must determine and qualify the appropriate curing parameters required for their unique application.

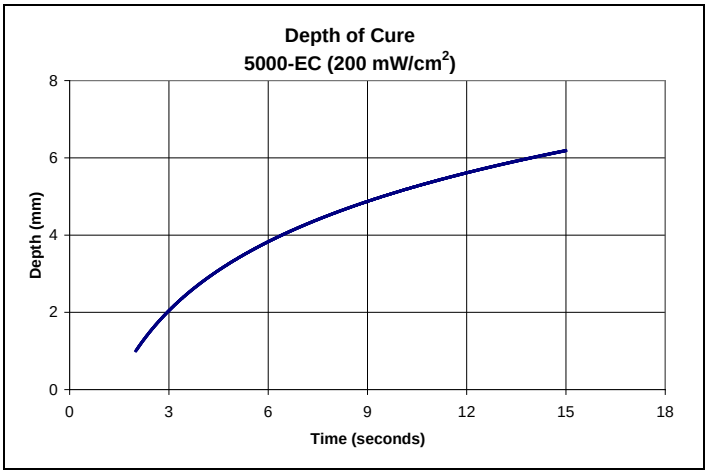
CURING GUIDELINES

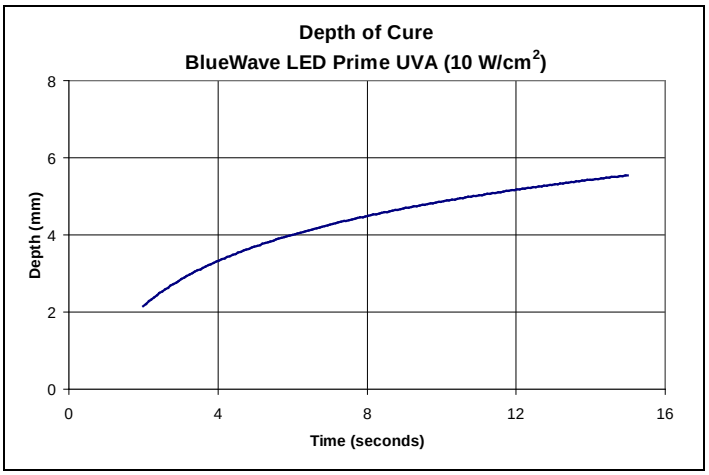
Dymax Curing System (Intensity)	Tack-Free Time, sec
2000-EC (50 mW/cm²)[A]	6
5000-EC (200 mW/cm²)[A]	1
BlueWave® LED Prime UVA (16 W/cm²)	2
BlueWave® 75 (5.0 W/cm²)[A]	1
BlueWave® 200 (10 W/cm²)[A]	1



DEPTH OF CURE

The graphs below show the increase in depth of cure as a function of exposure time with two different lamps at different intensities. A 9.5 mm [0.37 in] diameter specimen was cured in a polypropylene mold and cooled to room temperature. It was then released from the mold and the cure depth was measured.





OPTIMIZING PERFORMANCE AND HANDLING

1. This product cures with exposure to UV and visible light. Exposure to ambient and artificial light should be kept to a minimum before curing. Dispensing components including needles and fluid lines should be 100% light blocking, not just UV blocking.
2. All bond surfaces should be clean and free from grease, mold release, and other contaminants prior to dispensing the adhesive.
3. Cure and color transition speed are dependent upon many variables, including lamp intensity, distance from the light source, required depth of cure, bond gap, and percent light transmission of the substrate.
4. Oxygen in the atmosphere may inhibit surface cure. Surfaces exposed to air may require high-intensity (>150 mW/cm^2) UV light to produce a dry surface cure. Flooding the bond area with an inert gas, such as nitrogen, can also reduce the effects of oxygen inhibition.
5. Parts should be allowed to cool after cure before testing and subjecting to any loads.
6. In rare cases, stress cracking may occur in assembled parts. Three options may be explored to eliminate this problem. One option is to heat anneal the parts to remove molded-in stresses. A second option is to open the gap between mating parts to reduce stress caused by an interference fit. The third option is to minimize the amount of time the liquid adhesive remains in contact with the substrate(s) prior to curing.
7. Light curing generally produces some heat. If necessary, cooling fans can be placed in the curing area to reduce the heating effect on components.
8. At the point of curing, an air exhaust system is recommended to dissipate any heat and vapors formed during the curing process.

DISPENSING THE ADHESIVE

This material may be dispensed with a variety of manual and automatic applicators or other equipment as required. Questions relating to dispensing and curing systems for specific applications should be referred to Dymax Application Engineering.

CLEANUP

Uncured material may be removed from dispensing components and parts with organic solvents. Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods of removal.

PERFORMANCE AFTER TEMPERATURE EXPOSURE

Dymax light-curable materials typically have a lower thermal limit of -54˚C [-65˚F] and an upper limit of 150˚C [300˚F]. Many Dymax products can withstand temperatures outside of this range for short periods of time. Please contact Dymax Application Engineering if you need further assistance.

BIOCOMPATIBILITY

Polymerized Dymax MD® Medical Device adhesives are biocompatibility tested in accordance with ISO 10993 and/or USP Class VI. The completed tests are listed on each product data sheet. Copies of the test reports are available upon request. In all cases, it is the user's responsibility to determine and validate the suitability of these adhesives in the intended medical device. These adhesives have not been tested for prolonged or permanent implantation, and are only intended for use in short-term (<29 days) or single-use disposable-device applications. Dymax does not authorize their use in long-term implant applications. Customers using these materials for such applications do so at their own risk and take full responsibility for ensuring product safety and biocompatibility.

STERILIZATION

Compatible sterilization methods include gamma irradiation and ethylene oxide. Sterilization by autoclaving may be limited to certain applications. It remains the user's obligation to ascertain the effect of sterilization on the cured adhesive.

STORAGE AND SHELF LIFE

Store the material in a cool, dark place when not in use. Do not expose to light. This product may polymerize upon prolonged exposure to ambient and artificial light. Keep covered when not in use. This material has a six-month shelf life from date of shipment, unless otherwise specified, when stored between 10˚C [50˚F] and 32˚C [90˚F] in the original, unopened container.

GENERAL INFORMATION

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from skin with soap and water. Never use organic solvents to remove material from skin and eyes. For more information on the safe handling of this material, please refer to the Material Safety Data Sheet before use.